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Global Plastic Parts for Semiconductor Equipment Supply, Demand and Key Producers, 2026-2032

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Abstracts

The global Plastic Parts for Semiconductor Equipment market size is expected to reach $ 6276 million by 2032, rising at a market growth of 7.7% CAGR during the forecast period (2026-2032).

Plastic Parts for Semiconductor Equipment refers to polymer-based components and subassemblies used in semiconductor equipment and wafer-fab utility systems where corrosion resistance, ultra-cleanliness, low extractables/low particles, dimensional stability, ESD control, and (in some modules) low outgassing are required. In industry practice, this category is dominated by fluoropolymers for wet/chemical service—PFA parts, PTFE parts, PVDF parts—and high-performance engineering plastics for high-wear/high-temperature/precision/vacuum service—PEEK parts, PPS parts, PI (polyimide/PAI) parts—supplemented by General Engineering Plastics (GEPs) for non-wetted covers, frames, and general mechanical fixtures. The “semiconductor-grade” boundary is typically defined by performance and qualification requirements for polymer materials/components used in ultrapure water and chemical distribution from bulk supply through facility distribution to process equipment; SEMI’s polymer specification for UPW and liquid chemical distribution explicitly includes purity, mechanical requirements, and packaging/traceability requirements, which is the prevailing qualification logic for many UHP polymer parts used around fab chemical delivery.

Across the applications, polymer selection maps to the dominant stressors: Cleaning & Wet Process Tools and Wafer Fab Facilities consume the highest volumes of fluoropolymer plastics in wetted paths (tanks, piping, fittings, valves, manifolds, filter housings) because wet benches and tanks are commonly specified in PP/PVDF/PFA/PTFE/ECTFE families depending on chemical set and temperature window. CMP Equipment is one of the most plastics-intensive tool categories due to

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abrasive slurry + reactive chemistries; the critical consumable is the retainer/retaining ring, where typical materials include PEEK and PPS (and, in some ecosystems, PET), selected for abrasion and chemical resistance. Plating & Electrochemical Tools, Etch, and parts of Deposition (CVD/PVD/ALD/Epi) also pull UHP fluoropolymers in chemical delivery and chamber-adjacent fixtures, while PI/PAI and related high-temperature/vacuum-capable plastics are common in dry/vacuum zones where ultra-low outgassing is needed. Lithography Track/Coater & Developer, Metrology & Inspection, and Wafer Handling/EFEM/FOUP & Carriers rely heavily on polymer-based handling interfaces (FOUPs/carriers, end-effectors/contact parts, ESD-managed plastics) and UHP chemical connections (e.g., PFA fittings engineered for leak-free, low dead-volume ultrapure fluid service).

The North American market for Plastic Parts for Semiconductor Equipment was valued at US$ 1,004 million in 2025 and is projected to reach US$ 1,666 million by 2032, at a CAGR of 7.78% from 2026 to 2032.

The European market for Plastic Parts for Semiconductor Equipment was valued at $ 528 million in 2025 and is projected to total US$ 776 million by 2032, at a CAGR of 6.0% from 2026 to 2032.

The China market for Plastic Parts for Semiconductor Equipment was valued at $ 613 million in 2025 and is projected to total US$ 1271 million by 2032, at a CAGR of 10.98% from 2026 to 2032.

The Japan market for Plastic Parts for Semiconductor Equipment was valued at $ 666.68 million in 2025 and is projected to total US$ 995 million by 2032, at a CAGR of 6.24% from 2026 to 2032.

The South Korea market for Plastic Parts for Semiconductor Equipment was valued at $ 361 million in 2025 and is projected to total US$ 584 million by 2032, at a CAGR of 7.29% from 2026 to 2032.

The global key companies in the Plastic Parts for Semiconductor Equipment market include Entegris, Pall Corporation, Shin-Etsu Polymer, PILLAR Corporation, Parker Hannifin, Gudeng Precision, Nichias Corporation, Daikin, Willbe S&T, GEMU Group, SMC, Miraial Co.,Ltd, Rochling Industrial, SIMONA AG and Saint-Gobain, etc. In 2025, the ten largest players accounted for approximately 59.85% of revenue.

Plastic Parts for Semiconductor Equipment is currently in a structural upcycle driven by

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both (i) sustained fab investment and (ii) rising wet-process/material intensity per wafer. SEMI projects front-end fab equipment spending to reach $110B in 2025 (sixth consecutive year of growth since 2020), while total semiconductor manufacturing equipment sales are projected to rise further toward a record $156B by 2027—expanding the global installed base that continuously consumes polymer components (UHP fluid paths, CMP polymers, wafer-handling plastics, facility plastics, etc.). In materials, SEMI's latest outlook shows wet chemicals continuing to expand (e.g., $3.7B in 2025 and $4.1B by 2026), mechanically pulling through more UHP polymer tubing/fittings/valves, filtration housings, tanks/liners, and tool-side chemical modules across "bulk > facility distribution > point-of-use." The industry's current baseline requirement is shifting from "engineering plastics availability" to qualification-grade performance and documentation: standards like SEMI F57 codify minimum requirements for UHP polymer materials/components in UPW and liquid chemical distribution, and leading suppliers increasingly market copy-exact / tighter process controls (material purity, stress control, dimensional stability, cleaning/packaging, traceability) as a prerequisite to win tool OEM and fab approvals.

Looking forward, the dominant trends and demand drivers are: (1) higher purity + lower defect budgets, which accelerate adoption of semiconductor-grade fluoropolymers and more rigorous contamination controls; (2) more ESD-managed and safety-engineered polymer systems, especially for solvent and non-conductive chemical lines—e.g., conductive-path PFA tubing/fittings designed to dissipate charge buildup while maintaining chemical purity; (3) AI/HBM-led capex and technology complexity, which lifts utilization of CMP/wet modules and increases replacement cycles for wear/consumable plastics in carrier heads, wet benches, and facility chemical distribution (supported by SEMI's raised equipment outlook and strong back-end recovery); (4) supplier localization + standards alignment, where regions (notably Asia) push domestic qualification of UHP polymer components to reduce lead-time and geopolitical risk while converging on SEMI-like specs; and (5) PFAS/fluoropolymer regulatory scrutiny becoming a strategic constraint, forcing the industry to invest in emissions control, compliance documentation, and "essential use" arguments for fluoropolymer-dependent applications (the EEA briefing highlights PFAS polymer impact/knowledge gaps and links to ongoing EU policy proposals).

This report studies the global Plastic Parts for Semiconductor Equipment demand, key companies, and key regions.

This report is a detailed and comprehensive analysis of the world market for Plastic Parts for Semiconductor Equipment, and provides market size (US$ million) and Year-

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over-Year (YoY) growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of Plastic Parts for Semiconductor Equipment that contribute to its increasing demand across many markets.

Highlights and key features of the study
Global Plastic Parts for Semiconductor Equipment total market, 2021-2032, (USD Million)
Global Plastic Parts for Semiconductor Equipment total market by region & country, CAGR, 2021-2032, (USD Million)
U.S. VS China: Plastic Parts for Semiconductor Equipment total market, key domestic companies, and share, (USD Million)
Global Plastic Parts for Semiconductor Equipment revenue by player, revenue and market share 2021-2026, (USD Million)
Global Plastic Parts for Semiconductor Equipment total market by Plastic Type, CAGR, 2021-2032, (USD Million)
Global Plastic Parts for Semiconductor Equipment total market by Application, CAGR, 2021-2032, (USD Million)

This report profiles major players in the global Plastic Parts for Semiconductor Equipment market based on the following parameters - company overview, revenue, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Entegris, Pall Corporation, Shin-Etsu Polymer, PILLAR Corporation, Parker Hannifin, KITZ SCT, White Knight (Graco), IWAKI, Ensinger Group, Nichias Corporation, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the world Plastic Parts for Semiconductor Equipment market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US$ Millions), by player, by regions, by Plastic Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

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Global Plastic Parts for Semiconductor Equipment Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Global Plastic Parts for Semiconductor Equipment Market, Segmentation by Plastic Type:

PFA Parts

PEEK Parts

PTFE Parts

General Engineering Plastics (GEPs)

PPS Parts

PVDF Parts

PI (Polyimide/PAI) Parts

Others

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Global Plastic Parts for Semiconductor Equipment Market, Segmentation by Product Type:

Plastic Valves, Fitting and Tubing

CMP Retainer Ring

Wafer Carriers

Others

Global Plastic Parts for Semiconductor Equipment Market, Segmentation by End Use:

Semiconductor Equipment (OEM)

Wafer Fab Facilities

Global Plastic Parts for Semiconductor Equipment Market, Segmentation by Application:

Cleaning & Wet Process Tools

CMP Equipment

Plating & Electrochemical Tools

Etch Equipment

Deposition Equipment (CVD/PVD/ALD/Epi)

Lithography Track/Coater & Developer

Metrology & Inspection Equipment

Wafer Handling/EFEM/FOUP & Carriers

Wafer Fab Facilities

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Others

Companies Profiled:

Entegris

Pall Corporation

Shin-Etsu Polymer

PILLAR Corporation

Parker Hannifin

KITZ SCT

White Knight (Graco)

IWAKI

Ensinger Group

Nichias Corporation

Sun Fluoro System

Daikin

Yodogawa Hu-Tech

Yasojima Proceed

PBI Advanced Materials

Miraial Co.,Ltd

Dainichi Shoji K.K.

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Mitsubishi Chemical

CKD Corporation

SMC

Junkosha Inc.

Asahi/America, Inc.

Fit-Line Global

C-Hawk Technology, Inc.

Pexco

DuPont

Rochling Industrial

Saint-Gobain

SIMONA AG

SAT Group

GEMU Group

Porvair Filtration Group

Willbe S&T

Cnus Co., Ltd.

Wooam Super Polymer

Chemiflon

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ENIB Co., Ltd.

EPK, Co., Ltd

IST Co., Ltd.

3SLine Co.,Ltd

3S Korea

CALITECH

Chuang King Enterprise

Gudeng Precision

ESI Products Inc.

Shen-Yueh Technology

Niche Applied Materials Co., Ltd.

Duratek

AKT Components

UIS Technologies

Jiangsu OKFLON Precision Manufacturing

Xiamen Baoshili Dustless Technology

HPRAY (Changzhou) Clean System Technology

Changzhou Junhang High Performance Composite Materials

Key Questions Answered

1. How big is the global Plastic Parts for Semiconductor Equipment market?

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2. What is the demand of the global Plastic Parts for Semiconductor Equipment market?
3. What is the year over year growth of the global Plastic Parts for Semiconductor Equipment market?
4. What is the total value of the global Plastic Parts for Semiconductor Equipment market?
5. Who are the Major Players in the global Plastic Parts for Semiconductor Equipment market?
6. What are the growth factors driving the market demand?

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